Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point[1)]	R_{thJS}		K/W
BCR192		≤ 240	
BCR192W		≤ 105	

Electrical Characteristics at T_A = 25°C, unless otherwise specified

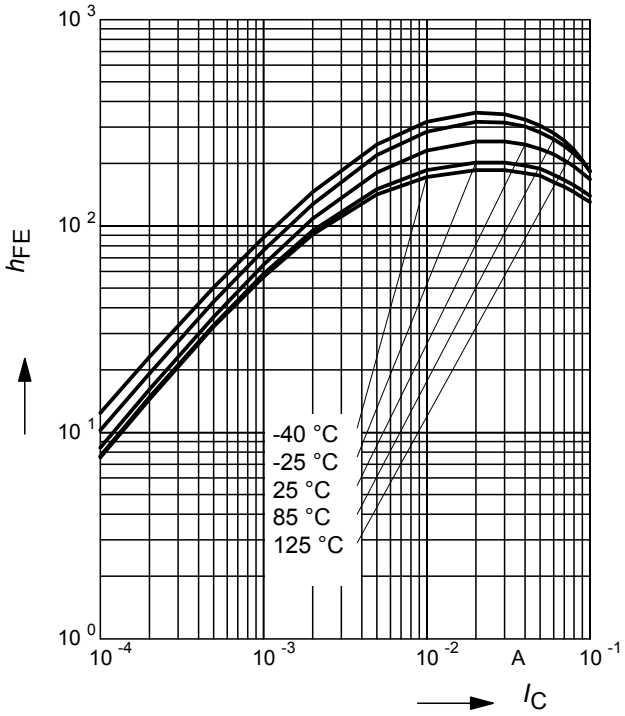
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage I_C = 100 µA, I_B = 0	$V_{(BR)CEO}$	50	-	-	V
Collector-base breakdown voltage I_C = 10 µA, I_E = 0	$V_{(BR)CBO}$	50	-	-	
Collector-base cutoff current V_{CB} = 40 V, I_E = 0	I_{CBO}	-	-	100	nA
Emitter-base cutoff current V_{EB} = 10 V, I_C = 0	I_{EBO}	-	-	227	µA
DC current gain[2)] I_C = 5 mA, V_{CE} = 5 V	h_{FE}	70	-	-	-
Collector-emitter saturation voltage[2)] I_C = 10 mA, I_B = 0,5 mA	V_{CEsat}	-	-	0.3	V
Input off voltage I_C = 100 µA, V_{CE} = 5 V	$V_{i(off)}$	0.5	-	1.2	
Input on voltage I_C = 2 mA, V_{CE} = 0,3 V	$V_{i(on)}$	0.8	-	2.5	
Input resistor	R_1	15	22	29	kΩ
Resistor ratio	R_1/R_2	0.42	0.47	0.52	-
AC Characteristics					
Transition frequency I_C = 10 mA, V_{CE} = 5 V, f = 100 MHz	f_T	-	200	-	MHz
Collector-base capacitance V_{CB} = 10 V, f = 1 MHz	C_{cb}	-	3	-	pF

[1]For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)

[2]Pulse test: t < 300µs; D < 2%

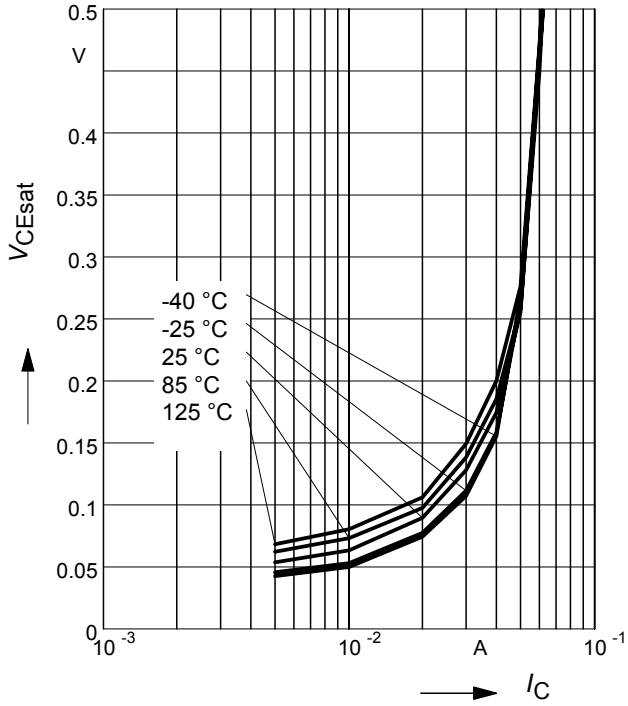
DC current gain h_{FE} = $f(I_C)$

V_{CE} = 5 V (common emitter configuration)



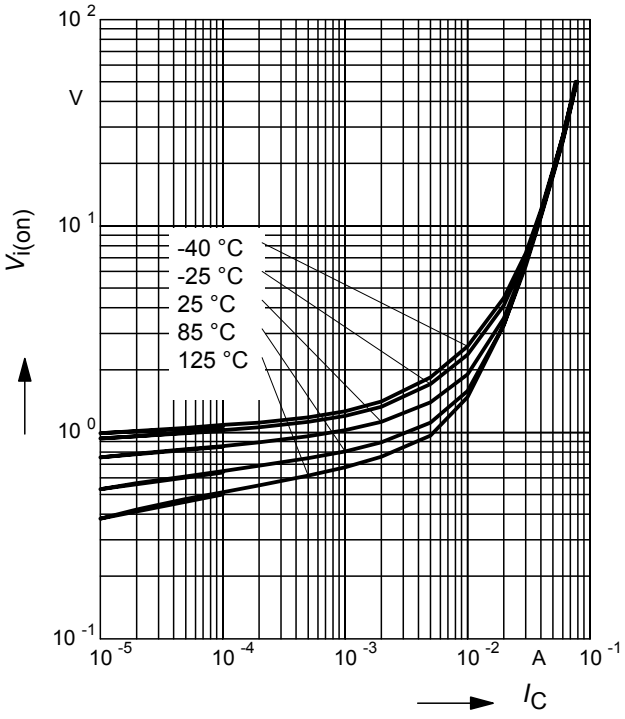
Collector-emitter saturation voltage

V_{CEsat} = $f(I_C)$, I_C/I_B = 20



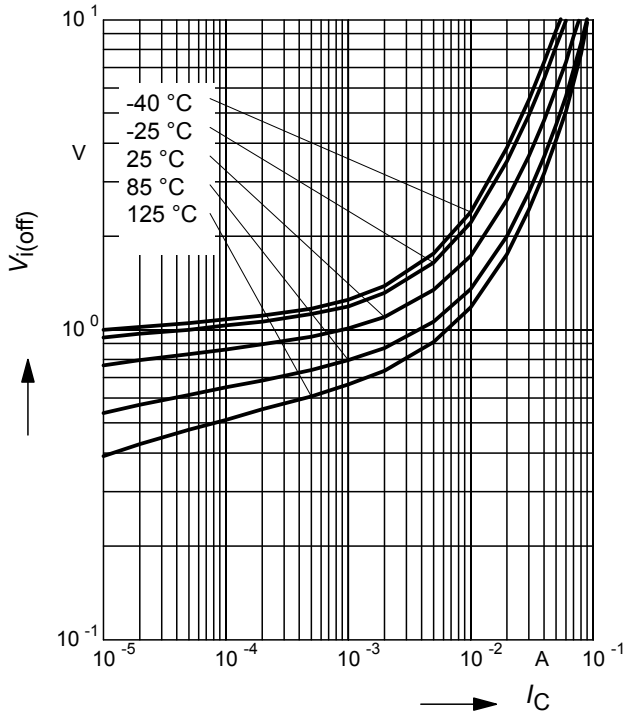
Input on Voltage $V_{i(on)}$ = $f(I_C)$

V_{CE} = 0.3V (common emitter configuration)

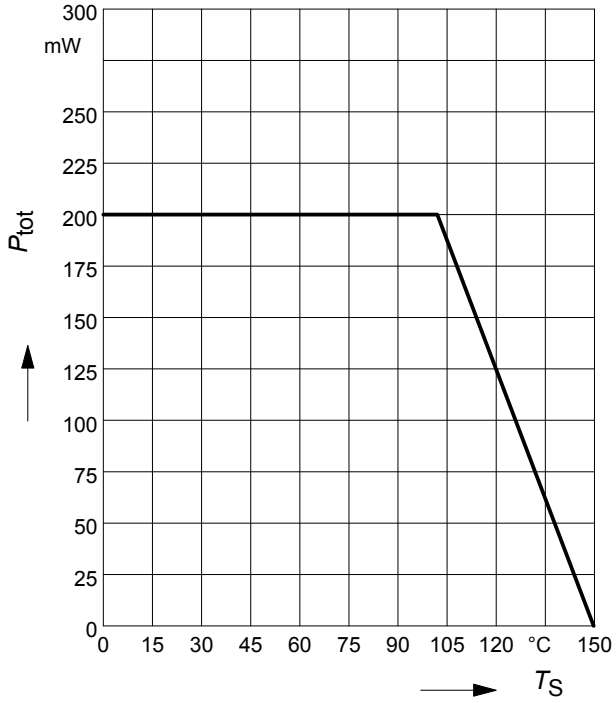


Input off voltage $V_{i(off)}$ = $f(I_C)$

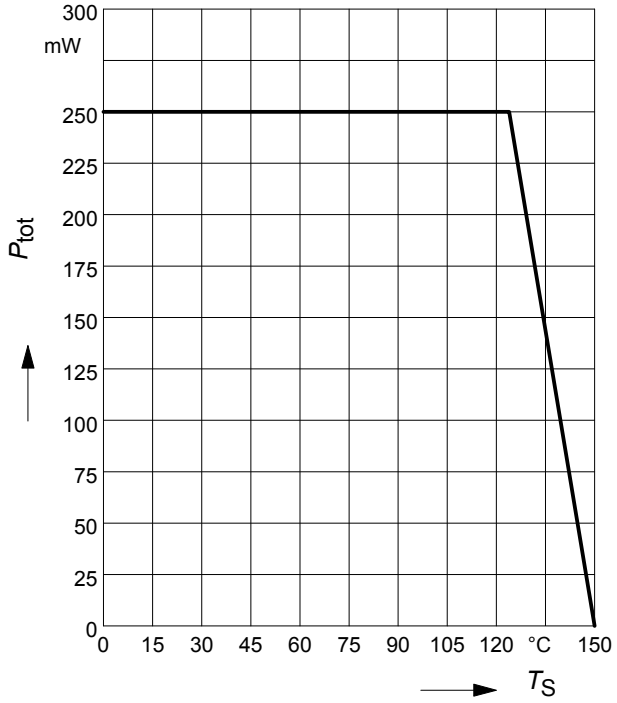
V_{CE} = 5V (common emitter configuration)



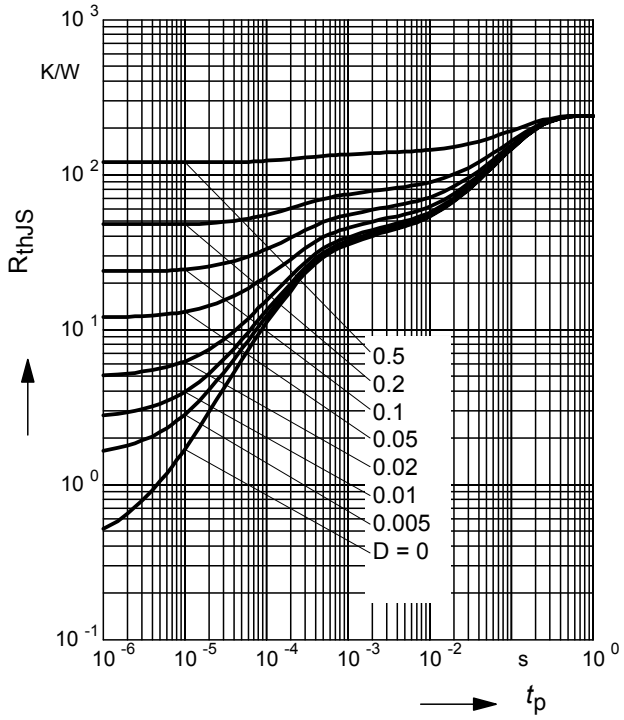
Total power dissipation $P_{tot} = f(T_S)$
BCR192



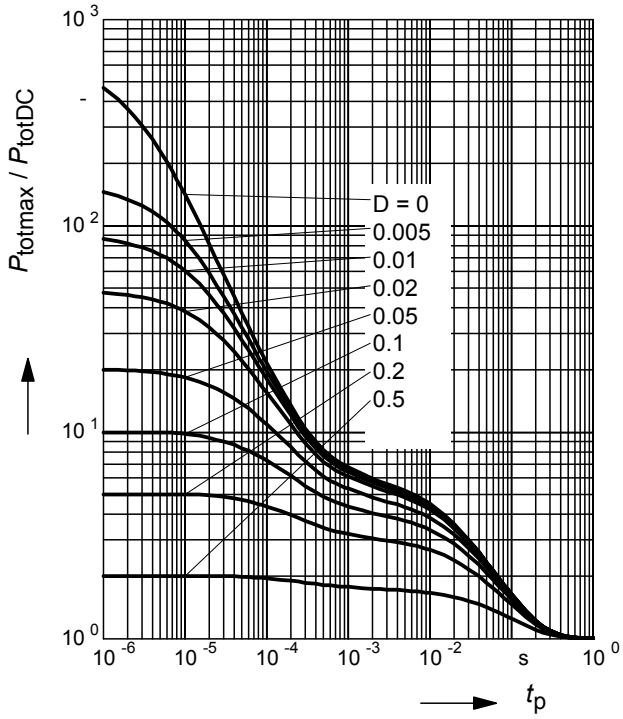
Total power dissipation $P_{tot} = f(T_S)$
BCR192W



Permissible Pulse Load $R_{thJS} = f(t_p)$
BCR192

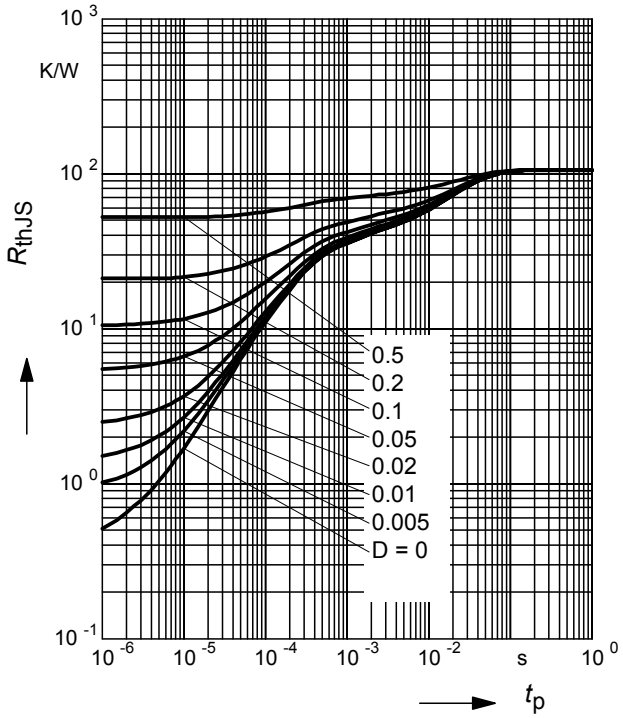


Permissible Pulse Load
$P_{totmax}/P_{totDC} = f(t_p)$
BCR192



Permissible Puls Load $R_{thJS} = f(t_p)$

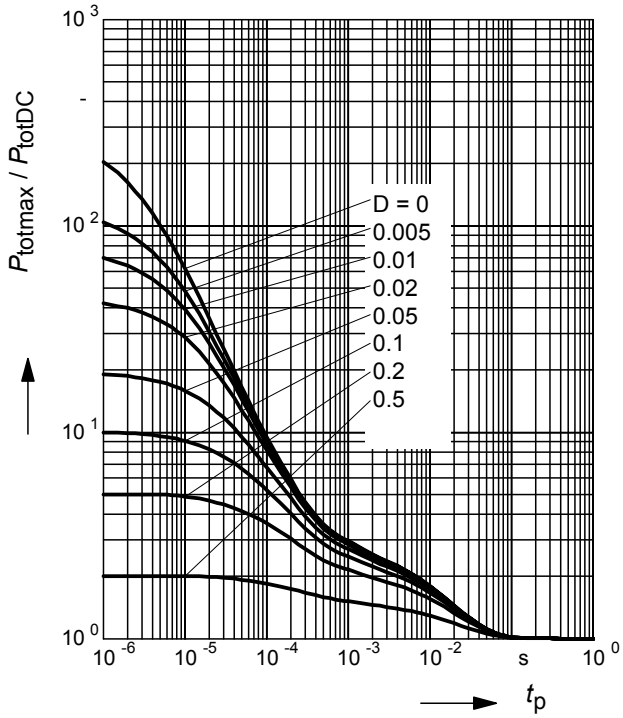
BCR192W



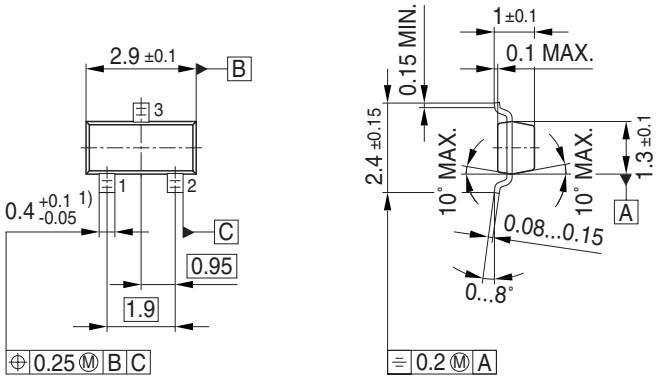
Permissible Pulse Load

$P_{totmax}/P_{totDC} = f(t_p)$

BCR192W

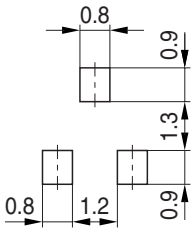


Package Outline

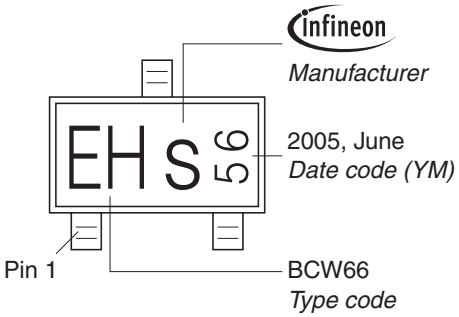


1) Lead width can be 0.6 max. in dambar area

Foot Print

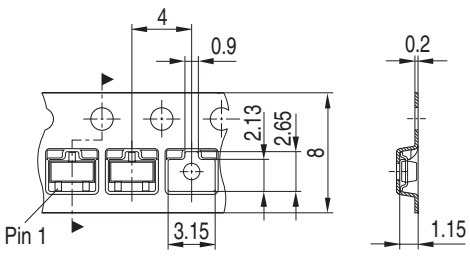


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
Reel ø330 mm = 10.000 Pieces/Reel



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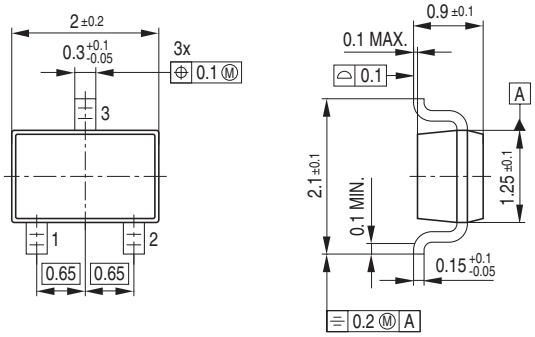

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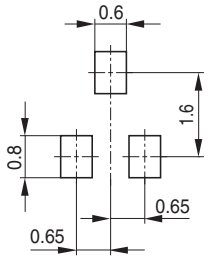

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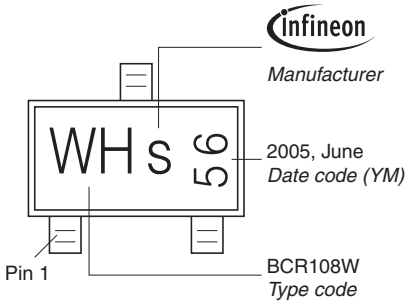

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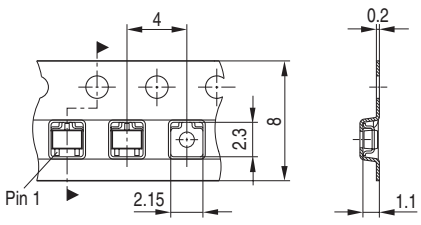

Edition 2009-11-16

Published by
Infineon Technologies AG
81726 Munich, Germany

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